



Product Change Notification

Change Notification #: 116174 - 00
Change Title: Intel® Server Spare P4000S Power Distribution Board AP4000E3V5PDB, PCN 116174-00, Product Design, Extend PMbus cable by 30mm (from 250mm to 280mm)
Date of Publication: March 22, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	April 6, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server Spare P4000S Power Distribution Board AP4000E3V5PDB:

- Extend PMbus cable by 30mm, from 250mm to 280mm

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change, but encourages customers to understand the change and determine the impact on their applications.

Please contact your local Intel Field Sales Rep if you have any further questions about this change.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
AP4000E3V5PDB	943589	H92236-001	H87822-206	H92236-002	H87822-207

PCN Revision History:

Date of Revision: March 22, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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